OCT 1 8 2004

IFW

hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as First Class Mail, in an envelope addressed to: MS Amendment, Commissioner for <u>Pätents</u>, P.O. Box 1450, Alexandria, VA 22313-1450, on the date shown below.

Dated: October 15, 2004

Signature:

Docket No.: 30205/39380

(PATENT)

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:

Jong Goo Jung et al.

Application No.: 10/603,976

Art Unit: 2813

Filed: June 25, 2003

Examiner: Stephen W. Smoot

For: CMP SLURRY COMPOSITIONS FOR OXIDE

FILMS AND METHODS FOR FORMING

METAL LINE CONTACT PLUGS USING THE

**SAME** 

## **AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION**

MS Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

## **INTRODUCTORY COMMENTS**

In response to the office action mailed on July 20, 2004, please amend the above-identified patent application as follows.

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper.

Remarks/Arguments begin on page 7 of this paper.